UTN6266-L Preliminary Power MOSFET

30A, 60V N-CHANNEL TRENCH MOSFET

■ DESCRIPTION

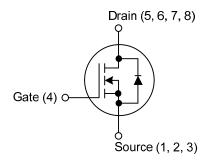
The UTC **UTN6266-L** is an N-Channel trench mosfet, it uses UTC's advanced technology to provide customers with a minimum on-state resistance, high switching speed and low gate charge.

The UTC **UTN6266-L** is suitable for Synchronus Rectification in DC/DC and AC/DC Converters and industrial and Motor Drive applications.

■ FEATURES

- * $R_{DS(ON)}$ <15m Ω @ V_{GS} =10V, I_D =20A $R_{DS(ON)}$ <19m Ω @ V_{GS} =4.5V, I_D =18A
- * Low gate charge
- * Low R_{DS(ON)}
- * High switching speed

■ SYMBOL



ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment							Dooking		
Lead Free	Halogen Free	Package	1	2	3	4	5	6	7	8	Packing	
UTN6266L-K08-5060-R	UTN6266G-K08-5060-R	DFN-8(5×6)	S	S	S	G	D	D	D	D	Tape Reel	

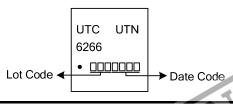
Note: Pin Assignment: G: Gate D: Drain S: Source

UTN6266G-K08-5060-R

(1) Packing Type
(2) K08-5060: DFN-8(5×6)

(3) G: Halogen Free and Lead Free, L: Lead Free

MARKING



1 DFN-8(5x6)

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■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	60	V
Sate-Source Voltage		V_{GSS}	±20	V
Drain Current	Continuous	I_D	30	Α
	Pulsed	I_{DM}	90	Α
Avalanche Current (Note 3)		I _{AS}	20	Α
Avalanche Energy (Note 2, 3)		E _{AS}	280	mJ
Power Dissipation		P_{D}	1.92	W
Junction Temperature	tion Temperature		+150	°C
Storage Temperature Range		T _{STG}	-55 ~ + 150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Single pulse width by junction temperature $T_{J(max)}$ =150°C.
- 3. L = 1.4mH, I_{AS} = 20A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25°C

■ THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ_{JA}	65	°C/W
Junction to Case	θ _{JC}	12	°C/W

Notes: 1. The θ_{JA} is the sum of the thermal impedance from junction to case θ_{JC} and case to ambient.

2. The value of θ_{JA} is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper.



ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise noted)

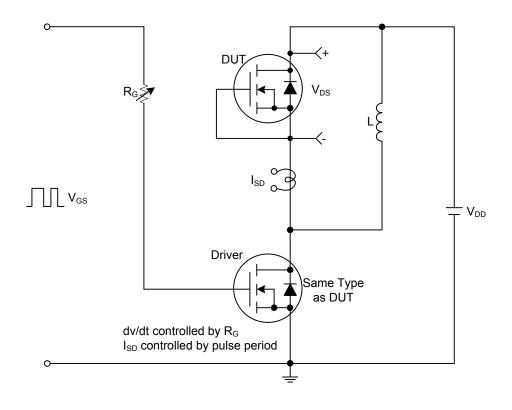
PARAMETER		SYMBOL	TEST CONDITIONS	TYP	MAX	UNIT	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	$I_D = 250 \mu A, V_{GS} = 0 V$	60			V
Zero Gate Voltage Drain Current		I _{DSS}	V _{DS} =60V, V _{GS} =0V			1	μA
			V _{DS} =60V, V _{GS} =0V, T _J =55°C			5	μΑ
Cata Pady Loakaga Current	Forward	- I _{GSS}	V_{GS} =+20V, V_{DS} =0V			+100	nA
Gate-Body Leakage Current	Reverse		V _{GS} =-20V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.0		2.5	V
Static Drain-Source On-State Resistance			V _{GS} =10V, I _D =20A		12	15	mΩ
		$R_{DS(ON)}$	V _{GS} =10V, I _D =20A, T _J =125°C		20.5	25	mΩ
			V _{GS} =4.5V, I _D =18A		15	19	mΩ
DYNAMIC PARAMETERS							
Input Capacitance		C_{ISS}			390		pF
Output Capacitance		Coss	V_{GS} =0V, V_{DS} =30V, f=1.0MHz		190		pF
Reverse Transfer Capacitance		C_{RSS}			170		pF
Gate Resistance		R_G	f=1.0MHz		1.1		Ω
SWITCHING PARAMETERS		-			=.		
Total Gate Charge		Q_{G}			6		nC
Gate to Source Charge		Q_GS	V_{GS} =10V, V_{DS} =30V, I_{D} =20A		0.5		nC
Gate to Drain Charge		Q_GD			0.5		nC
Turn-ON Delay Time		$t_{D(ON)}$			60		ns
Rise Time		t_R	V_{GS} =10V, V_{DS} =30V, R_L =1.5 Ω ,		75		ns
Turn-OFF Delay Time		$t_{D(OFF)}$	R_{GEN} =3 Ω		500		ns
Fall-Time		t_{F}			230		ns
SOURCE- DRAIN DIODE RATING	S AND CH	ARACTERIS'	TICS				
Maximum Body-Diode Continuous	Current	Is				30	Α
Drain-Source Diode Forward Voltage (Note2)		V_{SD}	I _S =1A, V _{GS} =0V		0.72	1	V

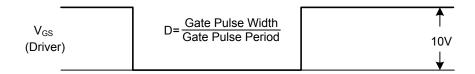
Notes: 1. Pulse width limited by $T_{J(MAX)}$

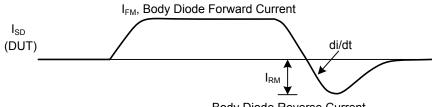
2. Pulse width ≤ 300us, duty cycle ≤ 2%.
3. Surface Mounted on 1in ² pad area.



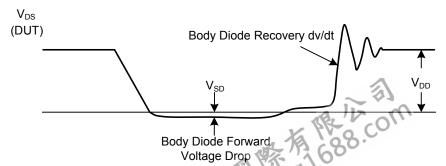
TEST CIRCUITS AND WAVEFORMS





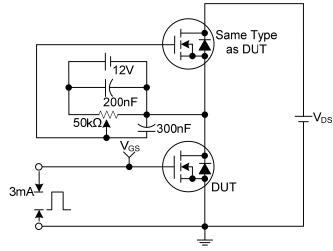


Body Diode Reverse Current

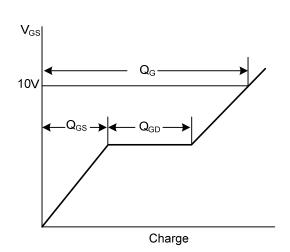


Peak Diode Recovery dv/dt Test Circuit and Waveforms

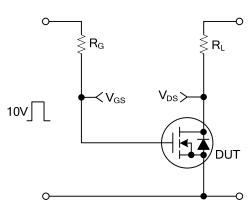
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



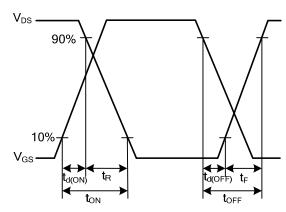
Gate Charge Test Circuit



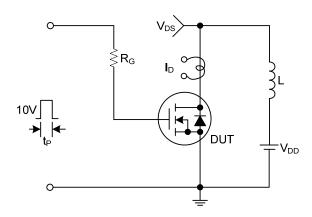
Gate Charge Waveforms



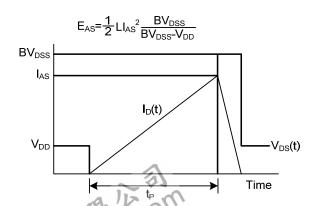
Resistive Switching Test Circuit



Resistive Switching Waveforms



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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